





ULTRA LOW LEAKAGE SURFACE MOUNT DIODE

Features

- Small Surface Mount Package
- Ultra-Low Reverse Leakage Current (5nA @ V_R = 75V)
- Low Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOD523
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe.
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.0014 grams (Approximate)

SOD523



Top View

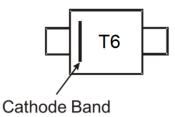
Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
BAV116T-7	Standard	SOD523	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



T6 = Product Type Marking Code



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	85	V
RMS Reverse Voltage		V _{R(RMS)}	60	V
Forward Continuous Current		I _{FM}	200	mA
Average Rectified Output Current		I ₀	100	mA
Repetitive Peak Forward Current		I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0ms @ t = 1.0s	I _{FSM}	4.0 1.0 0.5	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	280	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ heta JA}$	450	°C/W
Thermal Resistance Junction to Soldering Point	R _{0JS}	120	°C/W
Operating and Storage Temperature Range	T_J , T_{STG}	-65 to +150	°C

Electrical Characteristics (@ $T_A = \pm 25$ °C, unless otherwise specified.)

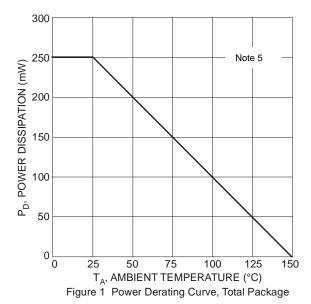
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	85	_	1	V	$I_R = 100\mu A$
Forward Voltage	VF	 - -	0.77 0.85 0.92 1.02	0.9 1.0 1.1 1.25	V	IF = 1.0mA IF = 10mA IF = 50mA IF = 150mA
Leakage Current (Note 6)	I _R		0.2 3.0 0.3	5.0 80 —	nA nA nA	$V_R = 75V$ $V_R = 75V$, $T_J = +150$ °C $V_R = 100V$
Total Capacitance	Ст	_	1.2	2.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t _{RR}	_	0.6	3.0	μs	$I_F = I_R = 10 \text{mA},$ $I_{RR} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

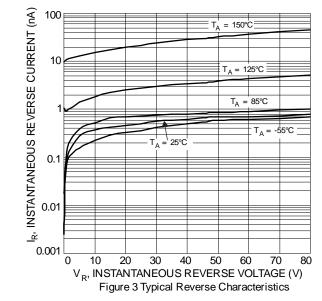
Notes:

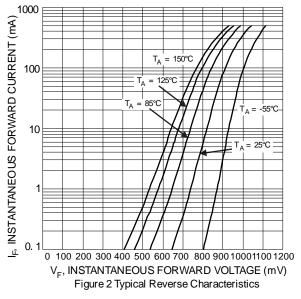
^{5.} Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

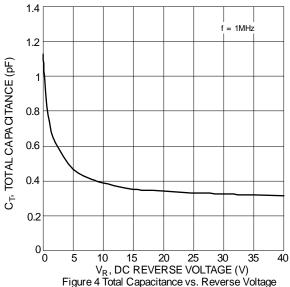
^{6.} Short duration pulse test used to minimize self-heating effect.







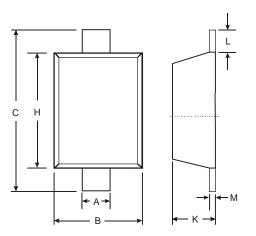






Package Outline Dimensions

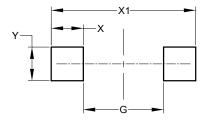
Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.



SOD523				
Dim	Min	Max		
Α	0.25	0.35		
В	0.70	0.90		
С	1.50	1.70		
Н	1.10	1.30		
K	0.55	0.65		
L	0.10	0.30		
M	0.10	0.12		
All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	0.80
Х	0.60
X1	2.00
Υ	0.70



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